

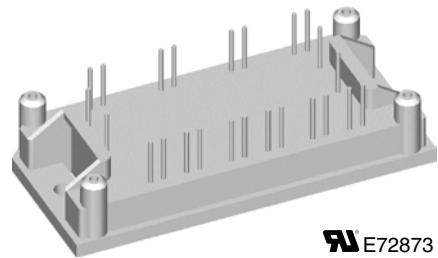
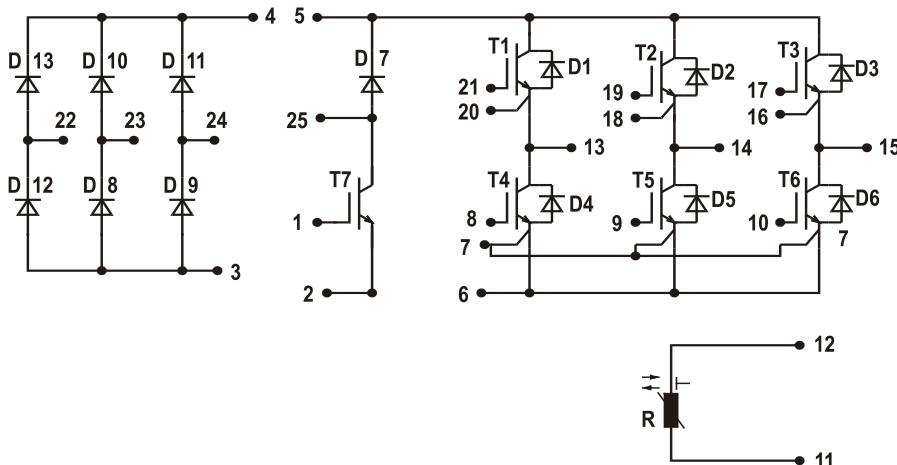
# Converter - Brake - Inverter Module (CBI 1)

## SPT IGBT

Three Phase Rectifier	Brake Chopper	Three Phase Inverter
$V_{RRM} = 1600 \text{ V}$	$V_{CES} = 1200 \text{ V}$	$V_{CES} = 1200 \text{ V}$
$I_{DAVM25} = 130 \text{ A}$	$I_{C25} = 19 \text{ A}$	$I_{C25} = 29 \text{ A}$
$I_{FSM} = 300 \text{ A}$	$V_{CE(sat)} = 2.9 \text{ V}$	$V_{CE(sat)} = 2.9 \text{ V}$

**Part name** (Marking on product)

MUBW30-12E6K



E72873

Pin configuration see outlines.

### Features:

- High level of integration - only one power semiconductor module required for the whole drive
- Inverter with SPT IGBTs
- low saturation voltage
- positive temperature coefficient
- fast switching
- short tail current
- Epitaxial free wheeling diodes with hiperfast and soft reverse recovery
- Industry standard package with insulated copper base plate and soldering pins for PCB mounting
- Temperature sense included

### Application:

- AC motor drives with
- Input from single or three phase grid
- Three phase synchronous or asynchronous motor
- Electric braking operation

### Package:

- UL registered
- Industry standard E1-pack

## Output Inverter T1 - T6

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{CES}$	collector emitter voltage	$T_{VJ} = 25^\circ\text{C}$ to $150^\circ\text{C}$		1200		V
$V_{GES}$	max. DC gate voltage	continuous		$\pm 20$		V
$V_{GEM}$	max. transient collector gate voltage	transient		$\pm 30$		V
$I_{C25}$	collector current	$T_C = 25^\circ\text{C}$	30		A	
$I_{C80}$		$T_C = 80^\circ\text{C}$	21		A	
$P_{tot}$	total power dissipation	$T_C = 25^\circ\text{C}$	130		W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 30 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	3.1 3.8	3.6	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.6 \text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	4.5	6.5	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	0.6	1	mA mA
$I_{GES}$	gate emitter leakage current	$V_{CE} = 0 \text{ V}; V_{GE} = \pm 20 \text{ V}$		200		nA
$C_{ies}$	input capacitance	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$		1180		pF
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 20 \text{ A}$		100		nC
$t_{d(on)}$	turn-on delay time	$T_{VJ} = 125^\circ\text{C}$	210			ns
$t_r$	current rise time		110			ns
$t_{d(off)}$	turn-off delay time		320			ns
$t_f$	current fall time		180			ns
$E_{on}$	turn-on energy per pulse		4.1			mJ
$E_{off}$	turn-off energy per pulse		1.5			mJ
$I_{CM}$	reverse bias safe operating area	$RBSOA; V_{GE} = \pm 15 \text{ V}; R_G = 68 \Omega$ $L = 100 \mu\text{H}; \text{clamped induct. load}$ $V_{CEmax} = V_{CES} - L_s \cdot di/dt$	$T_{VJ} = 125^\circ\text{C}$	45		A
$t_{sc}$ (SCSOA)	short circuit safe operating area	$V_{CE} = 900 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 68 \Omega; \text{non-repetitive}$	$T_{VJ} = 125^\circ\text{C}$	10		μs
$R_{thJC}$	thermal resistance junction to case	(per IGBT)			0.95	K/W
$R_{thCH}$	thermal resistance case to heatsink	(per IGBT)		0.35		K/W

## Output Inverter D1 - D6

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 150^\circ\text{C}$		1200		V
$I_{F25}$	forward current	$T_C = 25^\circ\text{C}$	49		A	
$I_{F80}$		$T_C = 80^\circ\text{C}$	32		A	
$V_F$	forward voltage	$I_F = 30 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	2.0	2.9	V V
$I_{RM}$	max. reverse recovery current	$T_{VJ} = 125^\circ\text{C}$	27		A	
$t_{rr}$	reverse recovery time		150		ns	
$E_{rec(off)}$	reverse recovery energy		tbd		μJ	
$R_{thJC}$	thermal resistance junction to case	(per diode)			0.9	K/W
$R_{thCH}$	thermal resistance case to heatsink	(per diode)		0.3		K/W

 $T_C = 25^\circ\text{C}$  unless otherwise stated

## Brake Chopper T7

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{CES}$	collector emitter voltage	$T_{VJ} = 25^\circ\text{C}$ to $150^\circ\text{C}$			1200	V
$V_{GES}$	max. DC gate voltage	continuous			$\pm 20$	V
$V_{GEM}$	max. transient collector gate voltage	transient			$\pm 30$	V
$I_{C25}$	collector current	$T_C = 25^\circ\text{C}$			19	A
$I_{C80}$		$T_C = 80^\circ\text{C}$			13	A
$P_{tot}$	total power dissipation	$T_C = 25^\circ\text{C}$			90	W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 15 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$	2.9	3.4	V
			$T_{VJ} = 125^\circ\text{C}$	3.5		V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.4 \text{ mA}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	4.5		V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$		0.5	mA
			$T_{VJ} = 125^\circ\text{C}$		0.8	mA
$I_{GES}$	gate emitter leakage current	$V_{CE} = 0 \text{ V}; V_{GE} = \pm 20 \text{ V}$			100	nA
$C_{ies}$	input capacitance	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$			600	pF
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 10 \text{ A}$			45	nC
$t_{d(on)}$	turn-on delay time	$T_{VJ} = 125^\circ\text{C}$			45	ns
$t_r$	current rise time				40	ns
$t_{d(off)}$	turn-off delay time				290	ns
$t_f$	current fall time				60	ns
$E_{on}$	turn-on energy per pulse				1.2	mJ
$E_{off}$	turn-off energy per pulse				1.1	mJ
$I_{CM}$	reverse bias safe operating area	$RBSOA; V_{GE} = \pm 15 \text{ V}; R_G = 82 \Omega$ $L = 100 \mu\text{H}$ ; clamped induct. load $V_{CEmax} = V_{CES} - L \cdot di/dt$	$T_{VJ} = 125^\circ\text{C}$		20	A
$t_{sc}$ (SCSOA)	short circuit safe operating area	$V_{CE} = 720 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 82 \Omega$ ; non-repetitive	$T_{VJ} = 125^\circ\text{C}$		10	$\mu\text{s}$
$R_{thJC}$	thermal resistance junction to case	(per IGBT)			1.35	K/W
$R_{thCH}$	thermal resistance case to heatsink	(per IGBT)			0.45	K/W

## Brake Chopper D7

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 150^\circ\text{C}$			1200	V
$I_{F25}$	forward current	$T_C = 25^\circ\text{C}$			15	A
$I_{F80}$		$T_C = 80^\circ\text{C}$			10	A
$V_F$	forward voltage	$I_F = 15 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$	3.5	V	
			$T_{VJ} = 125^\circ\text{C}$	2.0	V	
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ\text{C}$	0.06	mA	
			$T_{VJ} = 125^\circ\text{C}$	0.2	mA	
$I_{RM}$ $t_{rr}$	max. reverse recovery current reverse recovery time	$V_R = 600 \text{ V}; I_F = 10 \text{ A}$ $di_F/dt = -400 \text{ A}/\mu\text{s}$	$T_{VJ} = 125^\circ\text{C}$	13 110		A ns
$R_{thJC}$	thermal resistance junction to case	(per diode)			2.5	K/W
$R_{thCH}$	thermal resistance case to heatsink	(per diode)			0.85	K/W

 $T_C = 25^\circ\text{C}$  unless otherwise stated

**Input Rectifier Bridge D8 - D13**

Symbol	Definitions	Conditions	Maximum Ratings		
$V_{RRM}$	max. repetitive reverse voltage		1600		V
$I_{FAV}$	average forward current	sine 180°	$T_c = 80^\circ\text{C}$	31	A
$I_{DAVM}$	max. average DC output current	rectangular; $d = 1/3$ ; bridge	$T_c = 80^\circ\text{C}$	89	A
$I_{FSM}$	max. surge forward current	$t = 10 \text{ ms}; \sin 50 \text{ Hz}$	$T_c = 25^\circ\text{C}$	320	A
$P_{tot}$	total power dissipation		$T_c = 25^\circ\text{C}$	80	W

Symbol	Conditions	Characteristic Values				
		min.	typ.	max.		
$V_F$	forward voltage	$I_F = 30 \text{ A}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.0 1.1	1.35	V
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	0.02 0.4	mA	mA
$R_{thJC}$	thermal resistance junction to case	(per diode)	$T_{VJ} = 25^\circ\text{C}$		1.4	K/W
$R_{thCH}$	thermal resistance case to heatsink	(per diode)		0.45		K/W

**Temperature Sensor NTC**

Symbol	Definitions	Conditions	Ratings			
			min.	typ.	max.	Unit
$R_{25}$	resistance	$T_c = 25^\circ\text{C}$	4.45	4.7	5.0	kΩ
$B_{25/85}$				3510		K

**Module**

Symbol	Definitions	Conditions	Ratings			
			min.	typ.	max.	Unit
$T_{VJ}$	operating temperature		-40		125	°C
$T_{VJM}$	max. virtual junction temperature				150	°C
$T_{stg}$	storage temperature		-40		125	°C
$V_{ISOL}$	isolation voltage	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$			2500	V~
$M_d$	mounting torque	(M4)	2.0		2.2	Nm
$d_s$	creep distance on surface		12.7			mm
$d_A$	strike distance through air		12.7			mm
Weight				40		g

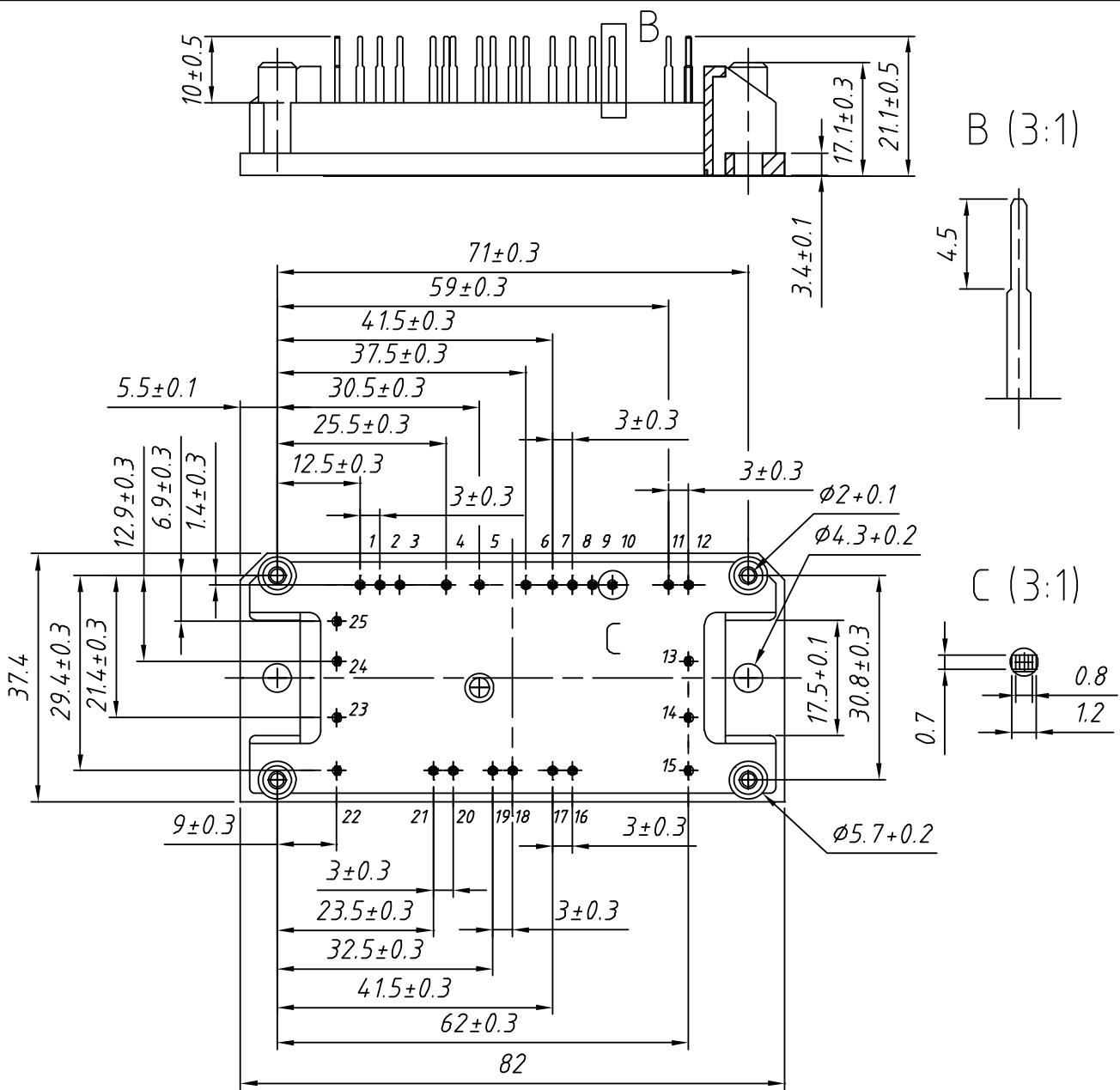
**Equivalent Circuits for Simulation**

Symbol	Definitions	Conditions	Ratings			
			min.	typ.	max.	Unit
$V_0$	rectifier diode	D8 - D13	$T_{VJ} = 125^\circ\text{C}$	0.90		V
$R_0$			9			mΩ
$V_0$	IGBT	T1 - T6	$T_{VJ} = 125^\circ\text{C}$	1.10		V
$R_0$			90			mΩ
$V_0$	free wheeling diode	D1 - D6	$T_{VJ} = 125^\circ\text{C}$	1.5		V
$R_0$			14			mΩ
$V_0$	IGBT	T7	$T_{VJ} = 125^\circ\text{C}$	1.5		V
$R_0$			120			mΩ
$V_0$	free wheeling diode	D7	$T_{VJ} = 125^\circ\text{C}$	1.46		V
$R_0$			63			mΩ

 $T_c = 25^\circ\text{C}$  unless otherwise stated

## **Outline Drawing**

Dimensions in mm (1 mm = 0.0394")



## Product Marking

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MUBW 30-12E6K	MUBW30-12E6K	Box	10	499 323

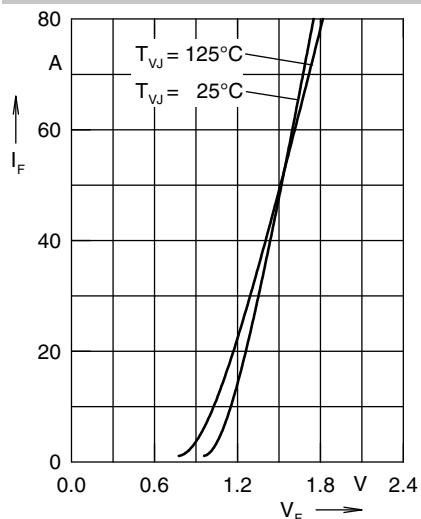
**Input Rectifier Bridge D8 - D13**


Fig. 1 Forward current versus voltage drop per diode

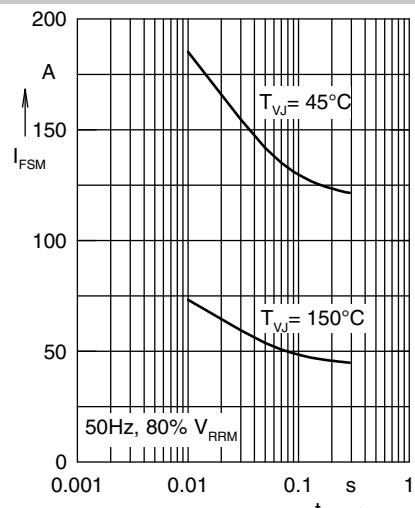


Fig. 2 Surge overload current

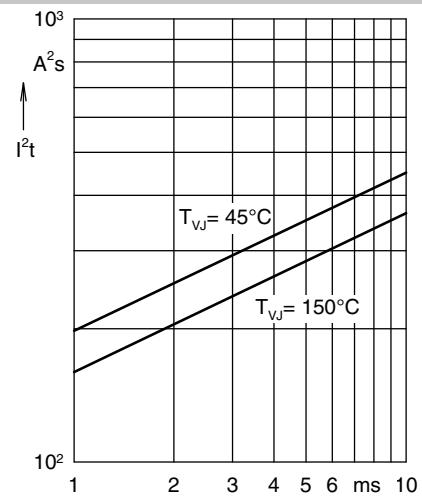


Fig. 3  $I^2t$  versus time per diode

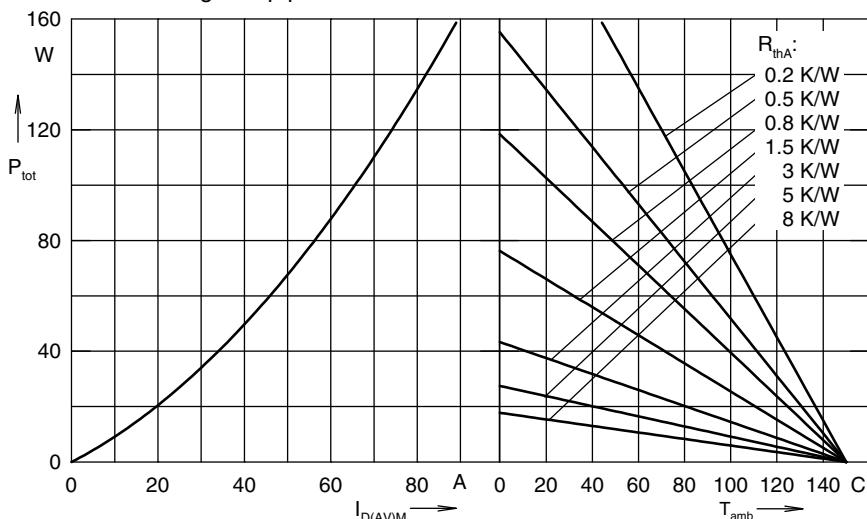


Fig. 4 Power dissipation versus direct output current and ambient temperature, sin 180°Fig.

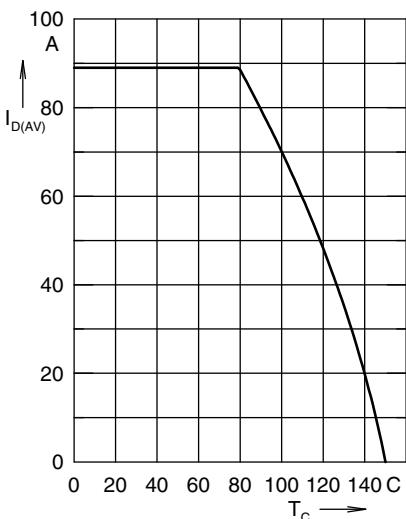


Fig. 5 Max. forward current vs. case temperature

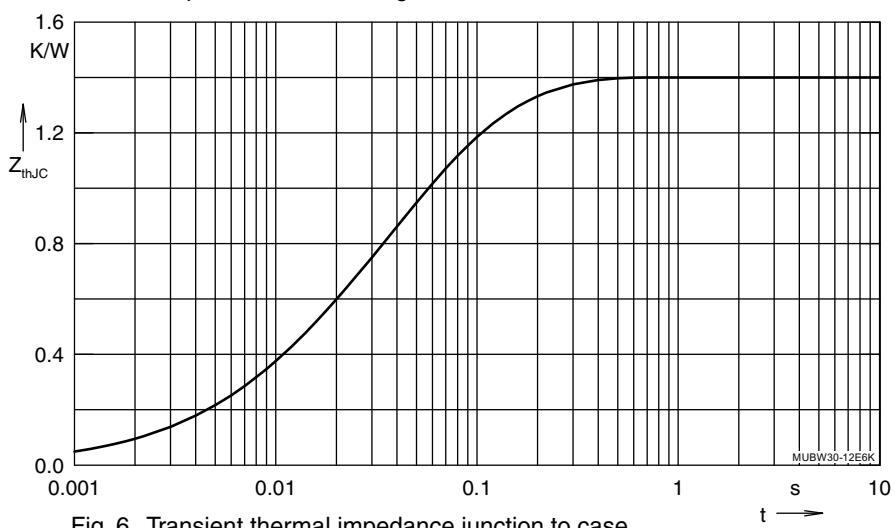


Fig. 6 Transient thermal impedance junction to case

## Output Inverter T1 - T6 / D1 - D6

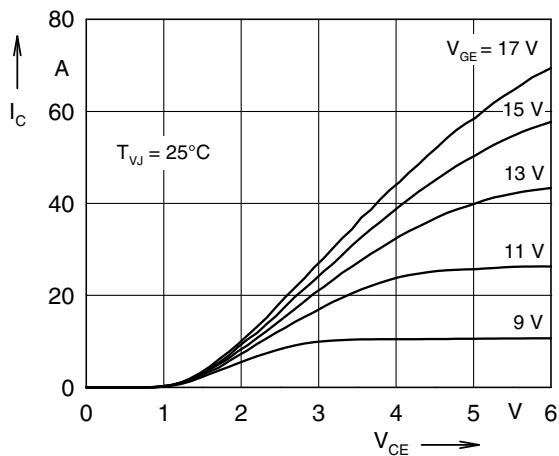


Fig. 7 Typ. output characteristics

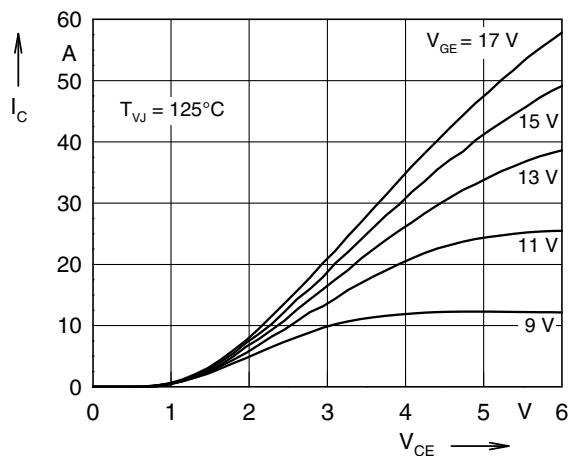


Fig. 8 Typ. output characteristics

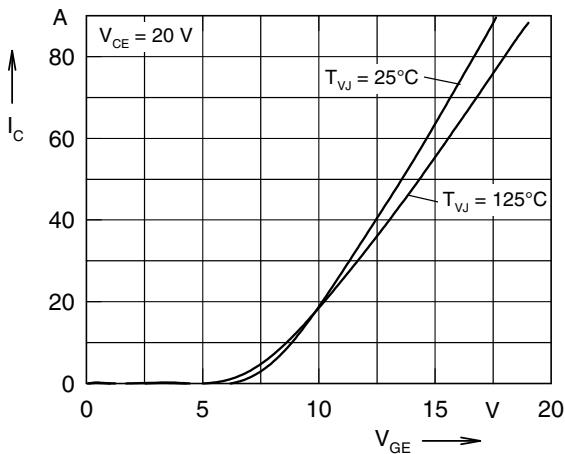


Fig. 9 Typ. transfer characteristics

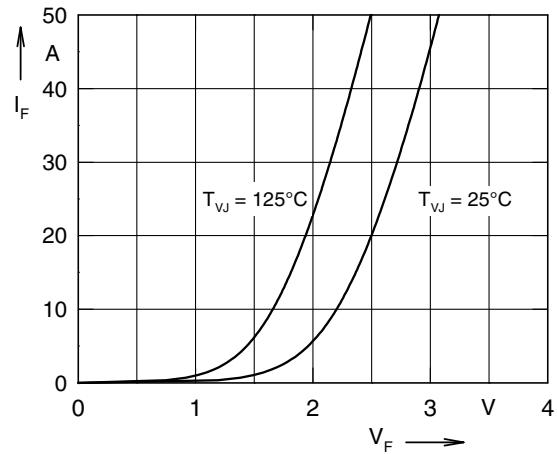


Fig. 10 Typ. forward characteristics of free wheeling diode

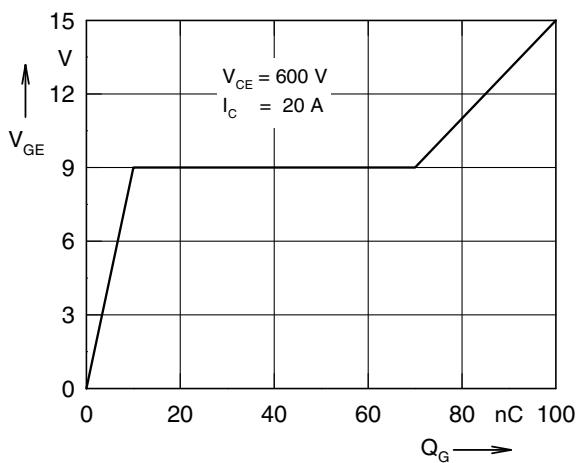


Fig. 11 Typ. turn on gate charge

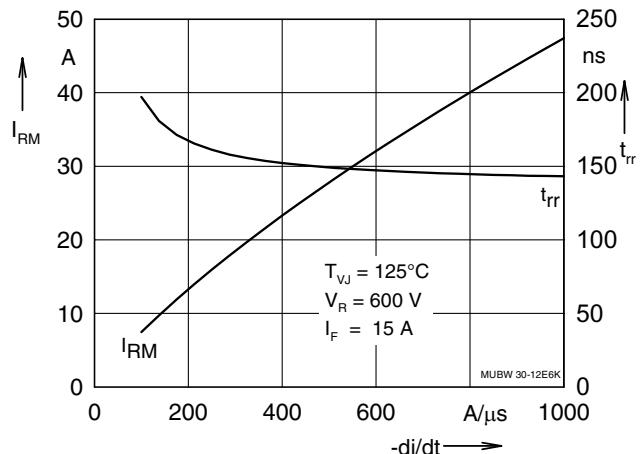


Fig. 12 Typ. turn off char. of free wheeling diode

## Output Inverter T1 - T6 / D1 - D6

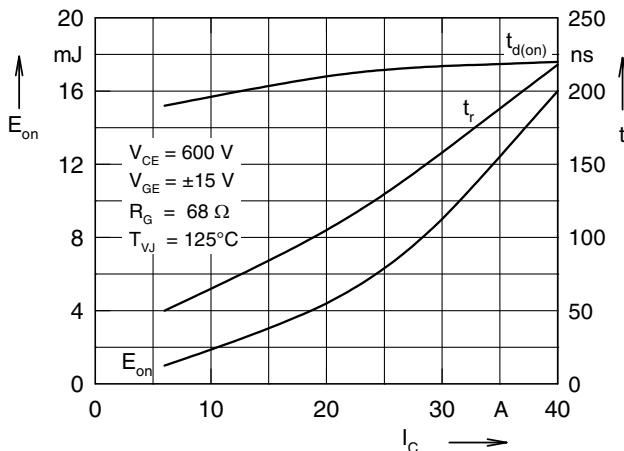


Fig. 13 Typ. turn on energy and switching times versus collector current

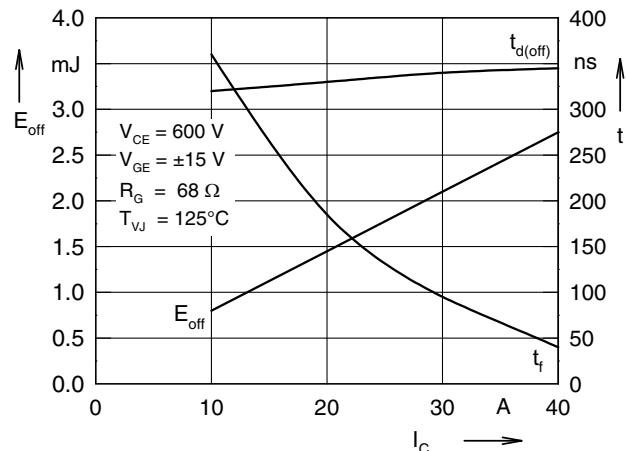


Fig. 14 Typ. turn off energy and switching times versus collector current

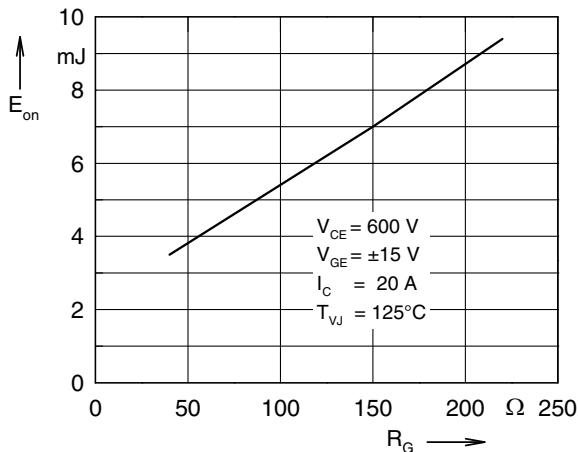


Fig. 15 Typ. turn on energy versus gate resistor

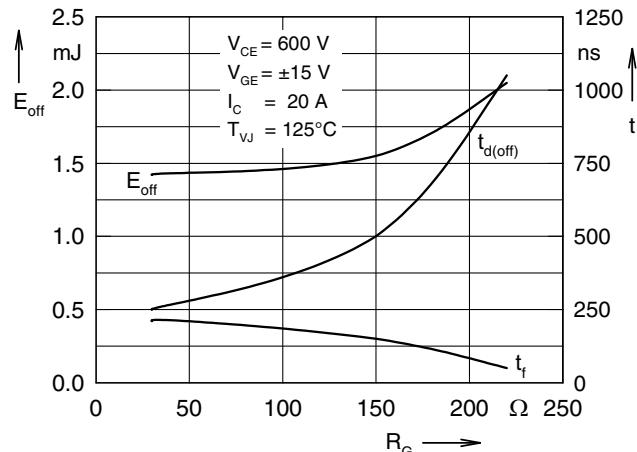


Fig. 16 Typ. turn off energy and switching times versus gate resistor

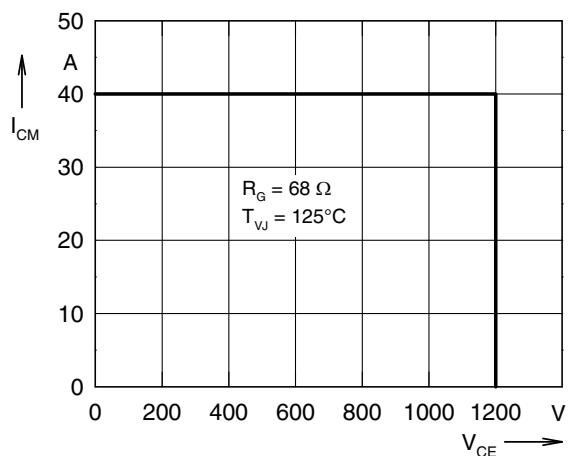


Fig. 17 Reverse biased safe operating area

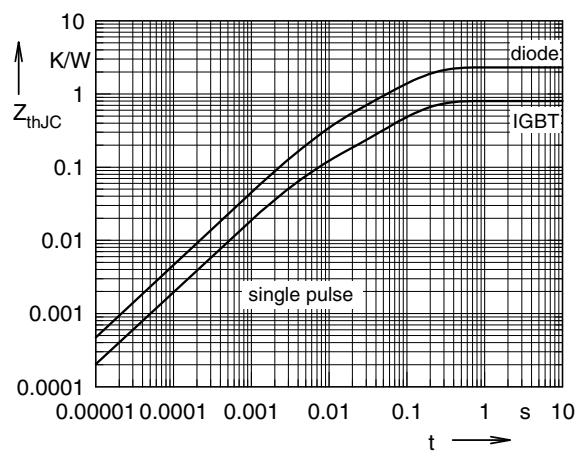


Fig. 18 Typ. transient thermal impedance

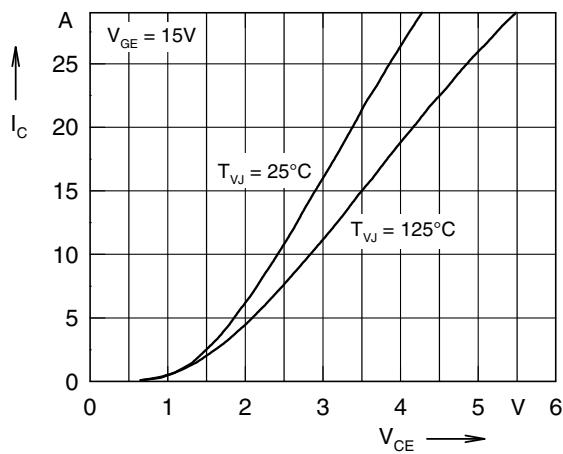
**Brake Chopper T7 / D7**


Fig. 19 Typ. output characteristics

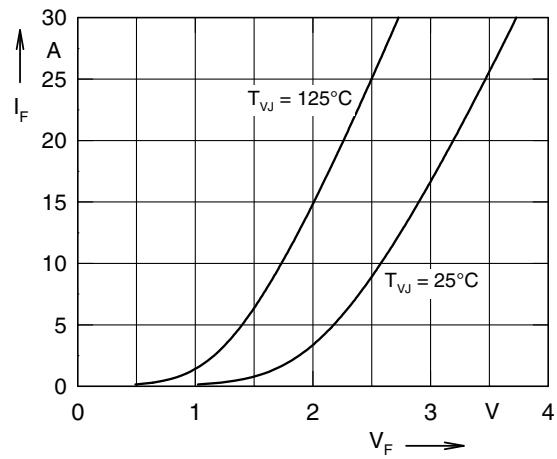
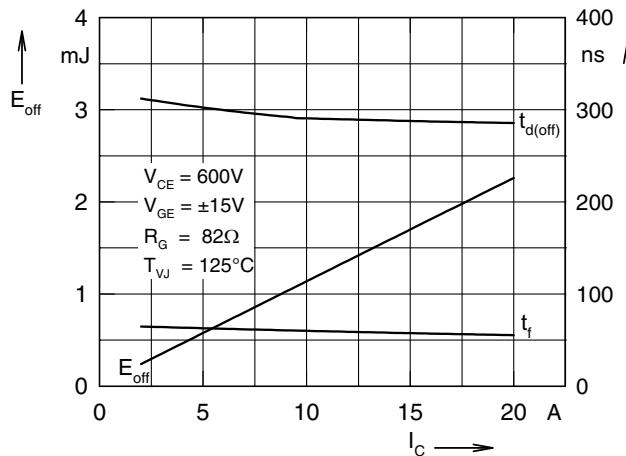
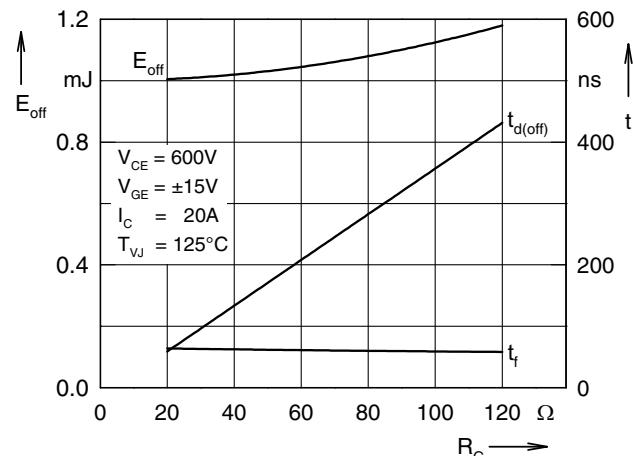
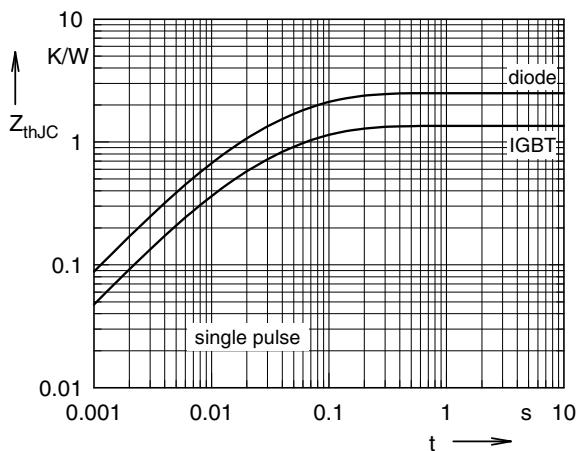
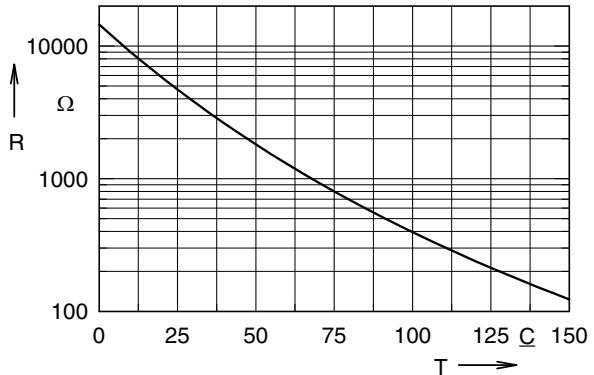

 Fig. 20 Typ. forward characteristics  
of free wheeling diode

 Fig. 21 Typ. turn off energy and switching  
times versus collector current

 Fig. 22 Typ. turn off energy and switching  
times versus gate resistor


Fig. 23 Typ. transient thermal impedance


 Fig. 24 Typ. thermistor resistance  
versus temperature